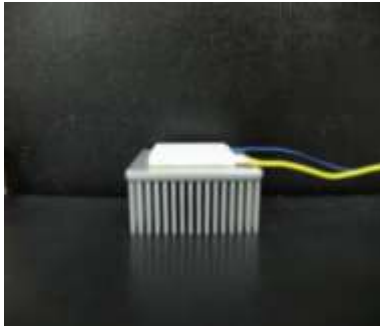


Thermal Interface Phase Change



TechFilm, LLC has introduced TMM4081, a phase change, thermal interface material that provides outstanding thermal performance.

TMM4081 registers 2.6 w/mK thermal conductivity, with a thermal impedance of $0.09 \text{ cm}^2\text{-}^\circ\text{K/W}$ at thickness.

The material flows at the phase change temperature and conforms to the surface features of the substrates.

TMM4081 is stable at room temperature for 6 months and has a melt point of 38°C .

Available in sheet or roll format up to 12 inches in width, this material can be provided as a film or preform to match a wide variety of electronic components.

TechFilm, LLC is a specialty adhesive company providing structural liquid and B-staged adhesive films and preforms for aerospace, automotive, electronics assembly/packaging, electromechanical, and general industrial manufacturers. Committed to customer service through direct sale, technical and R&D support, TechFilm responds to customer and industry needs with highly innovative products and services.
